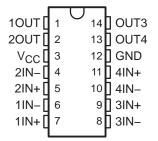
- Single Supply or Dual Supplies
- Wide Range of Supply Voltage:
 - Max Rating . . . 2 V to 36 V
 - Tested to 30 V . . . Non-V Devices
 - Tested to 32 V . . . V-Suffix Devices
- Low Supply-Current Drain Independent of Supply Voltage . . . 0.8 mA Typ
- Low Input Bias Current . . . 25 nA Typ
- Low Input Offset Current . . . 3 nA Typ (LM139)
- Low Input Offset Voltage . . . 2 mV Typ
- **Common-Mode Input Voltage Range Includes Ground**
- Differential Input Voltage Range Equal to Maximum-Rated Supply Voltage . . . ±36 V
- **Low Output Saturation Voltage**
- Output Compatible With TTL, MOS, and **CMOS**

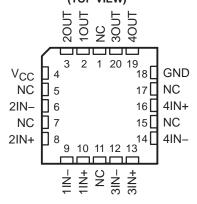
description/ordering information

These devices consist of four independent voltage comparators that are designed to operate from a single power supply over a wide range of voltages. Operation from dual supplies also is possible as long as the difference between the two supplies is 2 V to 36 V, and V_{CC} is at least 1.5 V more positive than the input common-mode voltage. Current drain is independent of the supply voltage. The outputs can be connected to open-collector outputs to other achieve wired-AND relationships.

LM139, LM139A . . . D, J, OR W PACKAGE LM239 . . . D, N, OR PW PACKAGE LM239A . . . D PACKAGE LM339, LM339A . . . D, DB, N, NS, OR PW PACKAGE LM2901 . . . D, N, NS, OR PW PACKAGE (TOP VIEW)



LM139, LM139A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The LM139 and LM139A are characterized for operation over the full military temperature range of -55°C to 125°C. The LM239 and LM239A are characterized for operation from -25°C to 125°C. The LM339 and LM339A are characterized for operation from 0°C to 70°C. The LM2901 is characterized for operation from -40°C to 125°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



description/ordering information (continued)

ORDERING INFORMATION

TA	V _{IO} max AT 25°C	MAX V _{CC}	PACKA	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
			PDIP (N)	Tube of 25	LM339N	LM339N
			0010 (D)	Tube of 50	LM339D	1.14000
			SOIC (D)	Reel of 2500	LM339DR	LM339
	5 mV	30 V	SOP (NS)	Reel of 2000	LM339NSR	LM339
			SSOP (DB)	Reel of 2000	LM339DBR	LM339
			T000D (DIA))	Tube of 90	LM339PW	1,000
000 1- 7000			TSSOP (PW)	Reel of 2000	LM339PWR	L339
0°C to 70°C			PDIP (N)	Tube of 25	LM339AN	LM339AN
			0010 (D)	Tube of 50	LM339AD	1.14000.4
			SOIC (D)	Reel of 2500	LM339ADR	LM339A
	2 mV	30 V	SOP (NS)	Reel of 2000	LM339ANSR	LM339A
			SSOP (DB)	Reel of 2000	LM339ADBR	L339A
			T000D (DIA)	Tube of 90	LM339APW	1,0004
			TSSOP (PW)	Reel of 2000	LM339APWR	L339A
			PDIP (N)	Tube of 25	LM239N	LM239N
	5 mV	30 V	0010 (D)	Tube of 50	LM239D	1.14000
			SOIC (D)	Reel of 2500	LM239DR	LM239
–25°C to 85°C			T000D (DIA))	Tube of 90	LM239PW	1,000
			TSSOP (PW)	Reel of 2000	LM239PWR	L239
		22.1	0010 (D)	Tube of 50	LM239AD	1110001
	2 mV	30 V	SOIC (D)	Reel of 2500	LM239ADR	LM239A
			PDIP (N)	Tube of 25	LM2901N	LM2901N
			COIC (D)	Tube of 50	LM2901D	1.00004
	7 \/	20.1/	SOIC (D)	Reel of 2500	LM2901DR	LM2901
	7 mV	30 V	SOP (NS)	Reel of 2000	LM2901NSR	LM2901
-40°C to 125°C			T000D (DIA))	Tube of 90	LM2901PW	1.0004
-40 C to 125 C			TSSOP (PW)	Reel of 2000	LM2901PWR	L2901
	7 :: \	20.17	SOIC (D)	Reel of 2500	LM2901VQDR	L2901V
	7 mV	32 V	TSSOP (PW)	Reel of 2000	el of 2000 LM2901VQPWR L	
	2 mV	32 V	SOIC (D)	Reel of 2500	LM2901AVQDR	L2901AV
	Z 111V	32 V	TSSOP (PW)	Reel of 2000	LM2901AVQPWR	L2901AV

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



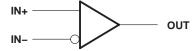
description/ordering information (continued)

ORDERING INFORMATION

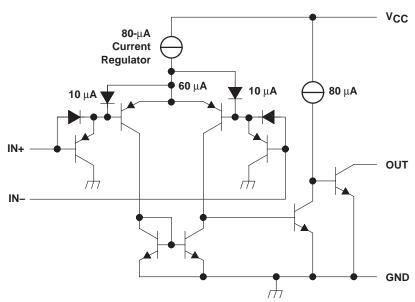
TA	V _{IO} max AT 25°C	MAX V _{CC}	PACKA	GE†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
			CFP (W)	CFP (W) Tube of 25		LM139W
			CDIP (J)	Tube of 25	LM139J	LM139J
	5 mV	30 V	LCCC (FK)	Tube of 55	LM139FK	LM139FK
			0010 (P)	Tube of 50	LM139D	LM400D
-55°C to 125°C			SOIC (D)	Reel of 2500	LM139DR	LM139D
-55 C to 125 C			CFP (W)	Tube of 25	LM139AW	LM139AW
			CDIP (J)	Tube of 25	LM139AJ	LM139AJ
	2 mV	30 V	LCCC (FK)	Tube of 55	LM139AFK	LM139AFK
			SOIC (D)	Tube of 50	LM139AD	LM139AD
			3010 (D)	Reel of 2500	LM139ADR	LIVITOSAD

[†]Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

symbol (each comparator)



schematic (each comparator)



All current values shown are nominal.



LM139, LM139A, LM239, LM239A, LM339, LM339A, LM2901, LM2901V QUAD DIFFERENTIAL COMPARATORS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC} (see Note 1)		36 V
Differential input voltage, V _{ID} (see Note 2)		±36 V
Input voltage range, V _I (either input)		0.3 V to 36 V
Output voltage, V _O		36 V
Output current, IO		20 mA
Duration of output short circuit to ground (see Note 3)		Unlimited
Package thermal impedance, θ _{JA} (see Notes 4 and 5):		
, 3 /()	DB package	
	N package	
	NS package	76°C/W
	PW package	113°C/W
Package thermal impedance, θ_{JC} (see Notes 6 and 7):	FK package	5.61°C/W
	J package	15.05°C/W
	W package	14.65°C/W
Operating virtual junction temperature, T _J		150°C
Case temperature for 60 seconds: FK package		260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60	seconds: J package	300°C
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltage values, except differential voltages, are with respect to network ground.

- 2. Differential voltages are at IN+ with respect to IN-.
- 3. Short circuits from outputs to $V_{\hbox{CC}}$ can cause excessive heating and eventual destruction.
- Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_J(max) T_A)/θ_{JA}. Operating at the absolute maximum T_J of 150°C can affect reliability.
- 5. The package thermal impedance is calculated in accordance with JESD 51-7.
- 6. Maximum power dissipation is a function of $T_J(max)$, θ_{JC} , and T_C . The maximum allowable power dissipation at any allowable case temperature is $P_D = (T_J(max) T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
- 7. The package thermal impedance is calculated in accordance with MIL-STD-883.



electrical characteristics at specified free-air temperature, $V_{CC} = 5 \text{ V}$ (unless otherwise noted)

	DADAMETED		unizioniot	- +	L	M139		LN	1139A		UNIT	
	PARAMETER	TEST COI	NDITIONS†	T _A ‡	MIN	TYP	MAX	MIN	TYP	MAX	UNII	
V	Input offset voltage		V _{CC} = 5 V to 30 V, V _{IC} = V _{ICR} (min), V _O = 1.4 V			2	5		1	2	mV	
V _{IO}	Input offset voltage						9			4	IIIV	
	Input offset current	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\		25°C		3	25		3	25	nA	
lio	input onset current	V _O = 1.4 V		Full range			100			100	nA	
	longet biog gurrant	\/_ 1.1\/		25°C		-25	-100		-25	-100	~ ^	
ΙΒ	Input bias current	V _O = 1.4 V		Full range			-300			-300	nA	
	Common-mode			25°C	0 to V _{CC} -1.5			0 to V _{CC} -1.5			.,	
VICR	input-voltage range				0 to V _{CC} -2			0 to V _{CC} -2			V	
A _{VD}	Large-signal differential-voltage amplification	$V_{CC} \pm = \pm 7.5$ $V_{O} = -5 \text{ V to}$		25°C		200		50	200		V/mV	
	High-level output	V 4.V	V _{OH} = 5 V	25°C		0.1			0.1		nA	
ЮН	current	V _{ID} = 1 V	V _{OH} = 30 V	Full range			1			1	μΑ	
	Low-level output	V 4V	1 4 · · · A	25°C		150	400		150	400	\/	
VOL	voltage	$V_{ID} = -1 V$,	$I_{OL} = 4 \text{ mA}$	Full range			700			700	mV	
loL	Low-level output current	V _{ID} = -1 V,	V _{OL} = 1.5 V	25°C	6	16	_	6	16	_	mA	
Icc	Supply current (four comparators)	V _O = 2.5 V,	No load	25°C		0.8	2		0.8	2	mA	

[†] All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	TEST CON	L	UNIT			
			MIN	TYP	MAX	
Dognopos timo	R _L connected to 5 V through 5.1 kΩ,	100-mV input step with 5-mV overdrive		1.3		
Response time	C _L = 15 pF§, See Note 8	TTL-level input step		0.3		μs

§ C_L includes probe and jig capacitance.

NOTE 8: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.



[‡] Full range (MIN to MAX) for LM139 and LM139A is -55°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

LM139, LM139A, LM239, LM239A, LM339, LM339A, LM2901, LM2901V QUAD DIFFERENTIAL COMPARATORS

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electrical characteristics at specified free-air temperature, $V_{CC} = 5 \text{ V}$ (unless otherwise noted)

	PARAMETER	TEST CON	NDITIONS†	TA‡		M239 M339			//239A //339A		UNIT
				^	MIN	TYP	MAX	MIN	TYP	MAX	
	land offertual tens		V _{CC} = 5 V to 30 V, V _{IC} = V _{ICR} (min), V _O = 1.4 V			2	5		1	3	
VIO	Input offset voltage	$V_0 = V_0 = V_0$					9			4	mV
1	Input effect ourrent	\/- 4.4\/		25°C		5	50		5	50	~ ^
IO	Input offset current	V _O = 1.4 V		Full range			150			150	nA
1	lamint bina anymout	\/- 4 4\/		25°C		-25	-250		-25	-250	A
ΙΒ	Input bias current	V _O = 1.4 V		Full range			-400			-400	nA
	Common-mode				0 to V _{CC} -1.5			0 to V _{CC} -1.5			.,
VICR	input-voltage range			Full range	0 to V _{CC} -2			0 to V _{CC} -2			V
AVD	Large-signal differential-voltage amplification	$V_{CC} = 15 \text{ V},$ $V_{O} = 1.4 \text{ V to}$ $R_{L} \ge 15 \text{ k}\Omega \text{ to}$		25°C	50	200		50	200		V/mV
	High-level output	V 4V	V _{OH} = 5 V	25°C		0.1	50		0.1	50	nA
ЮН	current	V _{ID} = 1 V	V _{OH} = 30 V	Full range			1			1	μΑ
V	Low-level output	V 4.V	1 4 4	25°C		150	400		150	400	mV
VOL	voltage	$V_{ID} = -1 V$,	$I_{OL} = 4 \text{ mA}$	Full range			700			700	mv
I _{OL}	Low-level output current	V _{ID} = -1 V,	V _{OL} = 1.5 V	25°C	6	16		6	16		mA
Icc	Supply current (four comparators)	V _O = 2.5 V,	No load	25°C		0.8	2		0.8	2	mA

[†] All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER	TEST CON	LM239, LM239A, LM339, LM339A			UNIT	
		MIN	TYP	MAX		
Deenenee time	R _I connected to 5 V through 5.1 kΩ,	100-mV input step with 5-mV overdrive		1.3		
Response time	C _L = 15 pF§, See Note 8	TTL-level input step	0.3		μs	

[§] C_L includes probe and jig capacitance.

NOTE 8: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.



[‡] Full range (MIN to MAX) for LM239 and LM239A is -25°C to 85°C, for LM339 and LM339A is 0°C to 70°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

electrical characteristics at specified free-air temperature, $V_{CC} = 5 \text{ V}$ (unless otherwise noted)

					LN	/12901		UNIT
	PARAMETER	TEST CO	NDITIONS†	T _A ‡	MIN	TYP	MAX	UNII
			Non Adordon	25°C		2	7	
.,	least effect value	$V_{IC} = V_{ICR}(min),$	Non-A devices	Full range			15	
VIO	Input offset voltage	$V_O = 1.4 \text{ V},$ $V_{CC} = 5 \text{ V to MAX}$	A suffice descions	25°C		1	2	mV
			A-suffix devices	Full range			4	
1	Innut effect ourrent	V- 1.4.V	/a = 1.4 \/			5	50	~ ^
IIO	Input offset current	V _O = 1.4 V		Full range			200	nA
1	lancet bing account	\/- 4 4\/		25°C		-25	-250	A
I _{IB}	Input bias current	V _O = 1.4 V		Full range			-500	nA
	Common-mode input-voltage				0 to V _{CC} -1.5			.,
VICR	range		Full range	0 to V _{CC} -2			V	
AVD	Large-signal differential-voltage amplification	$V_{CC} = 15 \text{ V},$ $V_{O} = 1.4 \text{ V to } 11.4 \text{ V}$ $R_{L} \ge 15 \text{ k}\Omega \text{ to } V_{CC}$,	25°C	25	100		V/mV
		., .,,	V _{OH} = 5 V	25°C		0.1	50	nA
ІОН	High-level output current	V _{ID} = 1 V	V _{OH} = V _{CC} MAX§	Full range			1	μΑ
			Non-V devices	2500		150	500	
VOL	Low-level output voltage	$V_{ID} = -1 V$, $I_{OI} = 4 \text{ mA}$	V-suffix devices	25°C		150	400	mV
		IOL - TIIA	All devices	Full range			700	
lOL	Low-level output current	$V_{ID} = -1 V$,	V _{OL} = 1.5 V	25°C	6	16		mA
loo	Supply current $V_O = 2.5 \text{ V},$ $V_{CC} = 2.5 \text{ V}$		V _{CC} = 5 V	25°C		0.8	2	mA
ICC	(four comparators)	No load	V _{CC} = MAX§	25.0		1	2.5	IIIA

[†] All characteristics are measured with zero common-mode input voltage, unless otherwise specified.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

DADAMETED	TEST COL	L	LINUT			
PARAMETER	TEST CON	IDITIONS	MIN	TYP	MAX	UNIT
Response time	R _L connected to 5 V through 5.1 kΩ,	100-mV input step with 5-mV overdrive		1.3		
Response time	C _L = 15 pF¶, See Note 8	TTL-level input step		0.3		μs

[¶]C_L includes probe and jig capacitance.

NOTE 8: The response time specified is the interval between the input step function and the instant when the output crosses 1.4 V.



[‡] Full range (MIN to MAX) for LM2901 is -40°C to 125°C. All characteristics are measured with zero common-mode input voltage, unless otherwise specified.







PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	n MSL Peak Temp ⁽³⁾
5962-7700801VCA	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
5962-87739012A	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
5962-8773901CA	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
5962-8773901DA	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
77008012A	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
7700801CA	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
7700801DA	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
JM38510/11201BCA	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139AD	ACTIVE	SOIC	D	14	50	None	CU NIPDAU	Level-3-245C-168 HR
LM139ADR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM139AFKB	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
LM139AJ	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139AJB	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139AN	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
LM139AW	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139AWB	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139D	ACTIVE	SOIC	D	14	50	None	CU NIPDAU	Level-1-220C-UNLIM
LM139DR	ACTIVE	SOIC	D	14	2500	None	CU NIPDAU	Level-1-220C-UNLIM
LM139FKB	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
LM139J	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139JB	ACTIVE	CDIP	J	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139N	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
LM139W	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
LM139WB	ACTIVE	CFP	W	14	1	None	A42 SNPB	Level-NC-NC-NC
LM239AD	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
LM239ADR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
LM239AN	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
LM239D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
LM239DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
LM239N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
LM239PW	ACTIVE	TSSOP	PW	14	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM239PWR	ACTIVE	TSSOP	PW	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM2901AVQDR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
LM2901AVQPWR	ACTIVE	TSSOP	PW	14	2000	None	CU NIPDAU	Level-1-250C-UNLIM
LM2901D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM





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Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
LM2901DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM2901N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
LM2901NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM2901PW	ACTIVE	TSSOP	PW	14	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM2901PWLE	OBSOLETE	TSSOP	PW	14		None	Call TI	Call TI
LM2901PWR	ACTIVE	TSSOP	PW	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM2901QD	OBSOLETE	SOIC	D	14		None	Call TI	Call TI
LM2901QN	OBSOLETE	PDIP	N	14		None	Call TI	Call TI
LM2901VQDR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
LM2901VQPWR	ACTIVE	TSSOP	PW	14	2000	None	CU NIPDAU	Level-1-250C-UNLIM
LM339AD	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339ADBR	ACTIVE	SSOP	DB	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339ADR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339AN	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
LM339ANSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339APW	ACTIVE	TSSOP	PW	14	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM339APWR	ACTIVE	TSSOP	PW	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM339D	ACTIVE	SOIC	D	14	50	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339DBLE	OBSOLETE	SSOP	DB	14		None	Call TI	Call TI
LM339DBR	ACTIVE	SSOP	DB	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339DR	ACTIVE	SOIC	D	14	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339N	ACTIVE	PDIP	N	14	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
LM339NSLE	OBSOLETE	SO	NS	14		None	Call TI	Call TI
LM339NSR	ACTIVE	SO	NS	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
LM339PW	ACTIVE	TSSOP	PW	14	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM339PWLE	OBSOLETE	TSSOP	PW	14		None	Call TI	Call TI
LM339PWR	ACTIVE	TSSOP	PW	14	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
LM339Y	OBSOLETE			0		None	Call TI	Call TI

 $^{^{(1)}}$ The marketing status values are defined as follows:



PACKAGE OPTION ADDENDUM

18-Feb-2005

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

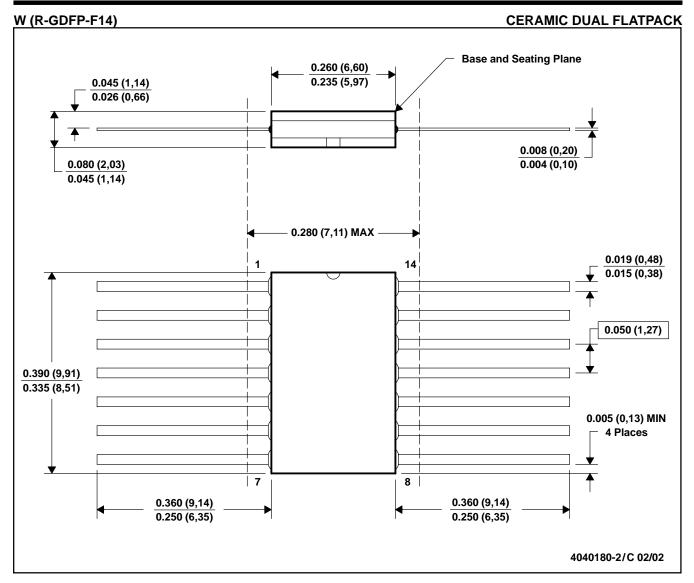
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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AB.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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